International Rectifier

IRL2703PbF

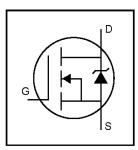
HEXFET® Power MOSFET

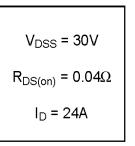
- Logic-Level Gate Drive
- Advanced Process Technology
- Dynamic dv/dt Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Lead-Free

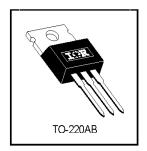
Description

Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve the lowest possible on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient device for use in a wide variety of applications.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 watts. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.







Absolute Maximum Ratings

	Parameter	Max.	Units
I _D @ T _C = 25°C	Continuous Drain Current, VGS @ 10V	24	
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V	17	 A
I _{DM}	Pulsed Drain Current ①	96	_
P _D @T _C = 25°C	Power Dissipation	45	W
	Linear Derating Factor	0.30	W/°C
V _{GS}	Gate-to-Source Voltage	±16	V
E _{AS}	Single Pulse Avalanche Energy ②	77	mJ
I _{AR}	Avalanche Current®	14	Α
E _{AR}	Repetitive Avalanche Energy①	4.5	mJ
dv/dt	Peak Diode Recovery dv/dt ③	5.0	V/ns
TJ	Operating Junction and	-55 to + 175	
T _{STG}	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	
	Mounting torque, 6-32 or M3 screw.	10 lbf•in (1.1N•m)	

Thermal Resistance

	Parameter	Min.	Тур.	Max.	Units
R _{BJC}	Junction-to-Case	——		3.3	
R _{0CS}	Case-to-Sink, Flat, Greased Surface		0.50		°C/W
Reja	Junction-to-Ambient			62	

IRL2703PbF

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	30	тур. ——		V	$V_{GS} = 0V, I_D = 250\mu A$
ΔV _{(BR)DSS} /ΔT,	Breakdown Voltage Temp. Coefficient		0.030		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance			0.040	_	V _{GS} = 10V, I _D = 14A ④
				0.060	Ω	V _{GS} = 4.5V, I _D = 12A ④
V _{GS(th)}	Gate Threshold Voltage	1.0			V	V _{DS} = V _{GS} , I _D = 250μA
g _{fs}	Forward Transconductance	6.4			S	$V_{DS} = 25V, I_{D} = 14A$
lana	Drain-to-Source Leakage Current			25		$V_{DS} = 30V, V_{GS} = 0V$
IDSS	Diam-to-Source Leakage Current			250	μΑ	V _{DS} = 24V, V _{GS} = 0V, T _J = 150°C
	Gate-to-Source Forward Leakage			100	nA	V _{GS} = 16V
I _{GSS}	Gate-to-Source Reverse Leakage			-100	IIA	V _{GS} = -16V
Qg	Total Gate Charge			15		I _D = 14A
Q _{gs}	Gate-to-Source Charge			4.6	nC	V _{DS} = 24V
Q _{gd}	Gate-to-Drain ("Miller") Charge			9.3		V _{GS} = 4.5V, See Fig. 6 and 13 ⊕
t _{d(on)}	Turn-On Delay Time		8.5			V _{DD} = 15V
t _r	Rise Time		140		ns	I _D = 14A
t _{d(off)}	Turn-Off Delay Time		12		115	$R_{G} = 12\Omega, V_{GS} = 4.5V$
t _f	Fall Time		20			R _D = 1.0Ω, See Fig. 10 ④
	Internal Dusin Industria	_	4.5			Between lead,
L _D	Internal Drain Inductance		4.5			6mm (0.25in.)
	Internal Source Inductance		7.5 —		nΗ	from package
Ls						and center of die contact
C _{iss}	Input Capacitance		450			$V_{GS} = 0V$
Coss	Output Capacitance		210		pF	V _{DS} = 25V
Crss	Reverse Transfer Capacitance		110			f = 1.0MHz, See Fig. 5

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions	
Is	Continuous Source Current		2	24	24	MOSFET symbol	
	(Body Diode)				A	showing the	
Ism	Pulsed Source Current			- 96	- 96		integral reverse
	(Body Diode) ①					•	
V _{SD}	Diode Forward Voltage			1.3	V	T _J = 25°C, I _S = 14A, V _{GS} = 0V ④	
t _{rr}	Reverse Recovery Time		65	97	ns	T _J = 25°C, I _F = 14A	
Qrr	Reverse RecoveryCharge	—	140	210	nC	di/dt = 100A/µs ⊕	
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L_S+L_D)					

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- $\begin{tabular}{ll} \mathbb{Q} V_{DD} = 15V, starting T_J = 25°C, $L=570\mu H$ \\ $R_{\mathbb{G}}$ = 25$\Omega, I_{AS} = 14A. (See Figure 12) \\ \end{tabular}$
- $\label{eq:loss_loss} \begin{array}{l} \text{ } \\ \text{ } \\$
- 4 Pulse width $\leq 300 \mu s$; duty cycle $\leq 2\%$.

IRL2703PbF

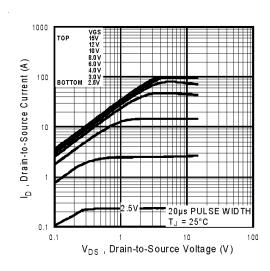


Fig 1. Typical Output Characteristics

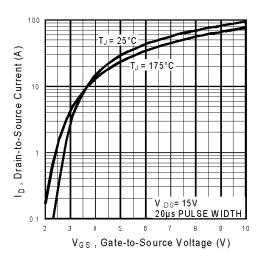


Fig 3. Typical Transfer Characteristics

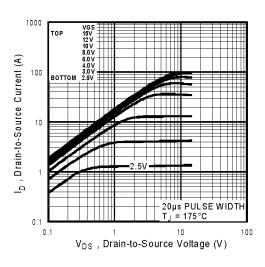


Fig 2. Typical Output Characteristics

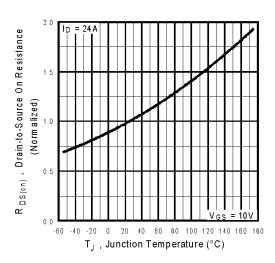


Fig 4. Normalized On-Resistance Vs. Temperature

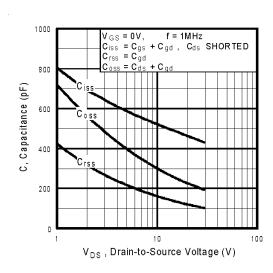


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

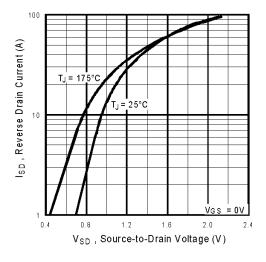


Fig 7. Typical Source-Drain Diode Forward Voltage

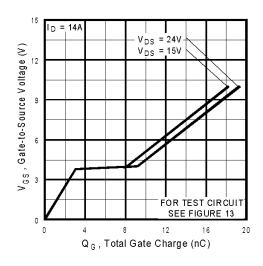


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

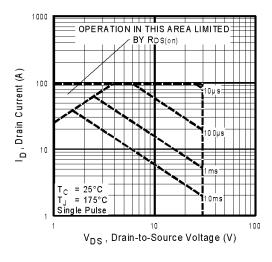


Fig 8. Maximum Safe Operating Area

IRL2703PbF

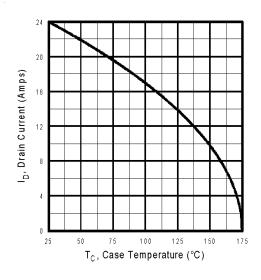


Fig 9. Maximum Drain Current Vs. Case Temperature

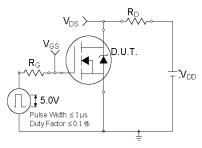


Fig 10a. Switching Time Test Circuit

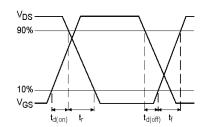


Fig 10b. Switching Time Waveforms

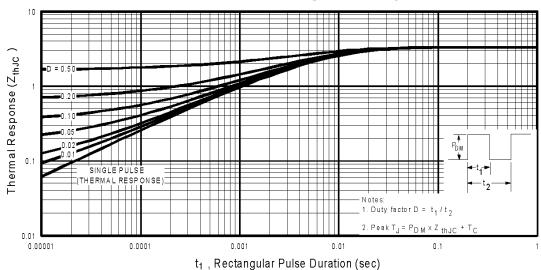


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

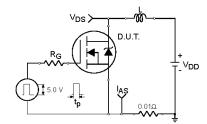


Fig 12a. Unclamped Inductive Test Circuit

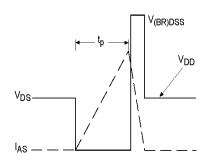


Fig 12b. Unclamped Inductive Waveforms

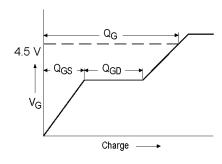


Fig 13a. Basic Gate Charge Waveform

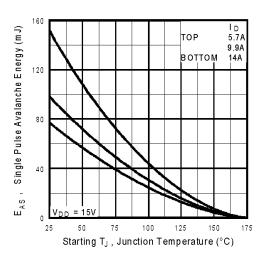


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

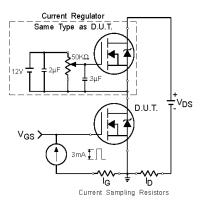
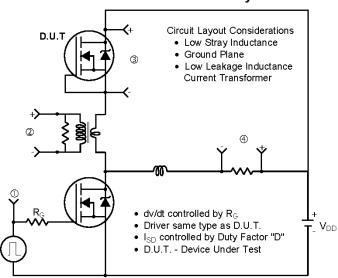


Fig 13b. Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit



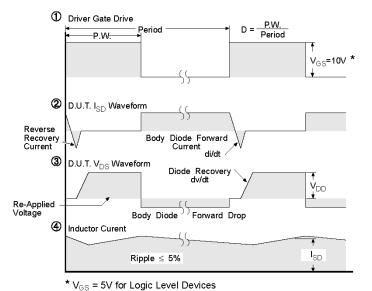
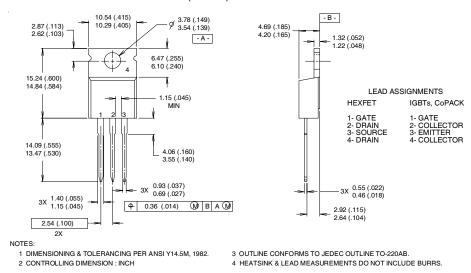


Fig 14. For N-Channel HEXFETS

TO-220AB Package Outline

Dimensions are shown in millimeters (inches)



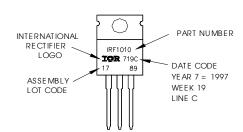
TO-220AB Part Marking Information

EXAMPLE: THIS IS AN IRF1010

LOT CODE 1789

ASSEMBLED ON WW 19, 1997 IN THE ASSEMBLY LINE "C"

Note: "P" in assembly line position indicates "Lead-Free'



Data and specifications subject to change without notice.



IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105

TAC Fax: (310) 252-7903

Visit us at www.irf.com for sales contact information.06/04

Note: For the most current drawings please refer to the IR website at: http://www.irf.com/package/

IMPORTANT NOTICE

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

For further information on the product, technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies office (www.infineon.com).

WARNINGS

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by Infineon manufacturer:

Other Similar products are found below:

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E GROUP A 5962-8877003PA NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE222 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE6400A NTE2910 NTE2916 NTE2956 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P54TU,LF SSM6P69NU,LF DMP22D4UFO-7B